

# **Surface Mount Ultra Fast Rectifiers**

### **Features**

- Low profile space
- Ideal for automated placement
- Glass passivated chip junctions
- Low forward voltage drop
- Low leakage current
- High forward surge capability
- High temperature soldering:
   260°C/10 seconds at terminals
- Component in accordance to RoHS 2002/95/1 and WEEE 2002/96/EC



• Case: JEDEC SOD-123FL molded plastic body over glass passivated chip

 Terminals: Solder plated, solderable per J-STD-002B and JESD22-B102D

• Polarity: Laser band denotes cathode end

• Weight: 0.017gram

# Pb



### **Major Ratings and Characteristics**

I <sub>F(AV)</sub>	0.5A				
V <sub>RRM</sub>	50 V to 1000 V				
I <sub>FSM</sub>	15 A				
I <sub>R</sub>	5 μΑ				
V <sub>F</sub>	1.0V, 1.3V, 1.7V				
T <sub>j</sub> max.	150 °C				

### Maximum Ratings & Thermal Characteristics

(T<sub>A</sub> = 25 °C unless otherwise noted)

Items	Symbol	DHE 0.5A	DHE 0.5B	DHE 0.5D	DHE 0.5E	DHE 0.5G	DHE 0.5J	DHE 0.5K	DHE 0.5M	UNIT
Maximum repetitive peak reverse voltage	$V_{RRM}$	50	100	200	300	400	600	800	1000	V
Maximum RMS voltage	$V_{RMS}$	35	70	140	210	280	420	560	700	V
Maximum DC blocking voltage	$V_{DC}$	50	100	200	300	400	600	800	1000	V
Maximum average forward rectified current	I <sub>F(AV)</sub>	0.5							Α	
Peak forward surge current 8.3 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	15						Α		
Thermal resistance from junction to ambient <sup>(1)</sup>	$R_{\theta JA}$	150						°C/W		
Operating junction and storage temperature range	$T_J,T_STG$	_55 to +150						$^{\circ}$		

Note 1: Mounted on P.C.B. with 0.036 x 0.06" (0.9 x 1.5mm) copper pad areas.

### **Electrical Characteristics** (T<sub>A</sub> = 25 °C unless otherwise noted)

Items	Test conditions		Symbol	DHE0.5A~0.5D	DHE0.5E~0.5G	DHE0.5J~0.5M	UNIT
Instantaneous forward voltage	I <sub>F</sub> =0.5A <sup>(2)</sup>		V <sub>F</sub>	1.0	1.3	1.7	V
Reverse current	V <sub>R</sub> =V <sub>DC</sub>	T <sub>A</sub> =25℃ T <sub>A</sub> =100℃	I <sub>R</sub>	5 50		μΑ	
Reverse recovery time	$I_F = 0.5 A$ , $I_{rr} = 0$	I <sub>R</sub> = 1.0 A , 0.25 A	t <sub>rr</sub>	5	0	75	nS

Note 2: Pulse test:300µs pulse width,1% duty cycle.





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### Characteristic Curves (T<sub>A</sub>=25 ℃ unless otherwise noted)

Fig.1 Forward Current Derating Curve

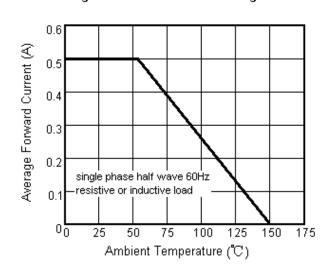


Fig.2 Maximum Non-Repetitive Peak Forward Surge Current

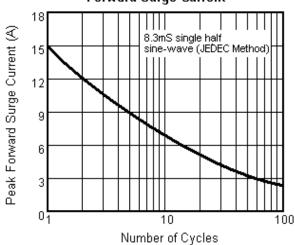


Fig.3 Typical Instantaneous Forward Characteristics

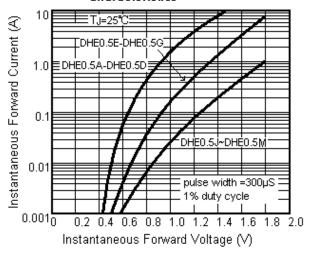
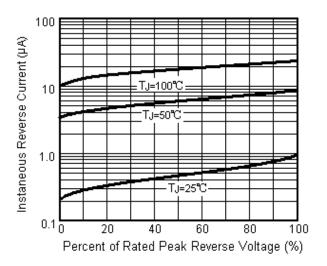


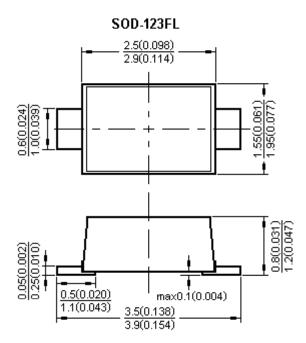
Fig.4 Typical Reverse Characteristics





# **Surface Mount Ultra Fast Rectifiers**

### **Package Outline**



Dimensions in millimeters and (inches)

#### **Notice**

- Product is intended for use in general electronics applications.
- Product should be worked less than the ratings; if exceeded, may cause permanent damage.or introduce latent failure mechanisms.
- The absolute maximum ratings are rated values and must not be exceeded during operation. The following are the general derating methods you design a circuit with a device.
  - $I_{\text{F(AV)}}$ : We recommend that the worst case current be no greater than 80% .
  - I<sub>FSM</sub>: This rating specifies the non-repetitive peak current. This is only applied for an abnormal operation, which the general during the lifespan of the device.
  - $T_J$ : Derate this rating when using a device in order to ensure high reliability. We recommend that the device be used at a  $T_J$  of below 125°C.
- TRR is registered trademark of Rising-sun Technology. Rising-sun Technology reserves the right to make changes to any product in this
  specification to improve reliability, functional characteristics, or design without notice.
- Rising-sun Technology does not assure any liability arising out of the applications or any product described in this specification.
- Rising-sun Technology advises customers to obtain the latest version of the device information before placing orders to verify that the
  required information is current.